

	PRODUCT NO	POS	DIM X	DIM Y
	87 75-X02	2 X I	- OBSOL	_ETED -
	- X 0 4	2 X 2	2	4.8
	- X 0 6	2 X 3	4	6.8
A	- X 0 8	2 X 4	6	8.8
	- X O	2 X 5	8	10.8
	- X 2	2 X 6	10	12.8
	- X 4	2 X 7	12	14.8
	- X 6	2 X 8	4	16.8
	- X 8	2 X 9	16	18.8
	- X 2 0	2 X I0	18	20.8
	- X 2 2	2 X II	20	22.8
	- X 2 4	2 X I2	22	24.8
	- X 2 6	2 X I 3	24	26.8
B	- X 2 8	2 X I 4	26	28.8
	- X 3 0	2 X I 5	28	30.8
	- X 3 2	2 X I6	30	32.8
	- X 3 4	2 X I 7	32	34.8
	- X 3 6	2 X I 8	34	36.8
	- X 3 8	2 X I9	36	38.8
	- X 4 0	2 X 20	38	40.8
	- X 4 2	2 X 21	40	42.8
	- X 4 4	2 X 22	42	44.8
c	- X 4 6	2 X 23	44	46.8
	- X 4 8	2 X 24	46	48.8
	- X 5 0	2 X 25	48	50.8

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PART NUMBER INFROMAT	LON
	LEAD FREE(SEE NOTE 7) TERMINAL PLATING BASE P/N

NOTES:

- MATERIAL BODY : GLASS FILLED PCT UL 94V-0 BEIGE PIN : PHOSPHOR BRONZE
- CUT SURFACE IS UNPLATED 2

2

- 3 TERMINAL RETENTION FORCE 0.5 Kg MIN
- 4 (i) SOLDERTAIL OF P/N: 87175-XXX IS TIN/LEAD PLATED. (ii) SOLDERTAIL OF P/N: 87175-XXXLF IS 100% MATTE TIN PLATED.
- THE HOUSING WILL WITHSTAND EXPOSURE TO 250°C PEAK 5 TEMPERATURE FOR 10 SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN.
- THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK 6) TEMPERATURE FOR IO SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.57MM MINIMUM THICK CIRCUIT BOARD.
- THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
- 8 A G SYMBOL WILL BE NEXT TO ANY DIMENSION, VIEW OR NOTE WHICH HAS BEEN MODIFIED WITH THE CURRENT DRAWING REVISION /G\

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www.fciconnect.com			surfac ISO I302			nce std ISO IIOI	projection	MM		
				TOLERANCES UNLESS OTHERWISE SP		SPECIFIED (D-		< →		
Dr	JANET		2000-05-30			Χ.Χ	-	size	Scale	è
Eng	JPEH		2000-06-01	ANGULAR	LINEAR	Χ.ΧΧ	±0.25	A 3	1:1	
Chr	KH LE	E	2010-01-21	0° ± 3° X.XXX		-	ECN	SI0-02	05	
Appr	JOEY	NG	2010-01-21	Produc	t family	/	MINITEK	Spec ref		-
		♥ MI	NITEK II				ou			Rev.
FCI 🗄 MINITEK II							07176)	
		+ VCC	(I.27 LEG)	ΗΤΡ			d w b			G
		catalo	g no			-	CUS	TOMER	sheet 2 of	3

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	DESCRIPTION	PLATING
	0.2µm Au	0
	0.76µm Au	
	UNASSIGNED	2
٨	0.38µm Au	3
А	UNASSIGNED	4
	UNASSIGNED	5
	UNASSIGNED	6

В

С

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	PRODUCT NO NOTE 5, 6 & 7	POS	DIM X	DIM Y
	87175-X02LF	2 X I	- OBSOL	ETED -
	- X 0 4 L F	2 X 2	2	4.8
	- X 0 6 L F	2 X 3	4	6.8
A	- X 0 8 L F	2 X 4	6	8.8
	-XIOLF	2 X 5	8	10.8
	- X 2 L F	2 X 6	10	12.8
	- X 4 L F	2 X 7	12	4 . 8
	- X 6 L F	2 X 8	4	16.8
	- X 8 L F	2 X 9	16	18.8
	- X 2 0 L F	2 X I O	18	20.8
	- X 2 2 L F	2 X II	20	22.8
	- X 2 4 L F	2 X I 2	22	24.8
	- X 2 6 L F	2 X I 3	24	26.8
B	- X 2 8 L F	2 X I 4	26	28.8
	- X 3 0 L F	2 X I 5	28	30.8
	- X 3 2 L F	2 X I6	30	32.8
	- X 3 4 L F	2 X I7	32	34.8
	- X 3 6 L F	2 X I 8	34	36.8
	- X 38L F	2 X I9	36	38.8
	- X 4 0 L F	2 X 20	38	40.8
	- X 4 2 L F	2 X 2 I	40	42.8
	- X 4 4 L F	2 X 22	42	44.8
С	- X 4 6 L F	2 X 23	44	46.8
	- X 4 8 L F	2 X 24	46	48.8
	- X 5 0 L F	2 X 25	48	50.8

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surface www.fciconnect.com ISO I302 TOLERANCES UN 2000-05-30 2000-06-01 Dr JANET ANGULAR Eng JPEH Chr KH LEE LIN 2010-01-21 0° ±3° Appr JOEY NG 2010-01-21 Product fa ➡ MINITEK II FC VCC (I.27 LEG) HTP catalog no 3 PDM: Rev:G

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				CON	IFIDENT	IAL	
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amily	/	MINITEK	Spea	c ref		-	
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	_	CUS	ТОМЕ	R	sheet 3 of	3	

STATUS: Released Printed: Nov 04, 2010

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